

TE Internal #: 2081570-1 OS 2.9 RF Interface, Jack, 50 Ω , Screw, 40 GHz Operating Frequency, Cable-to-Board, 1 Position, Wire & Cable, -55 – 125 °C [-67 – 257 °F], Straight

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Connectors > RF Connectors > Coax Connectors











RF Interface: OS 2.9

RF Connector Style: Jack

RF Connector Mated Outer Diameter (Approximate): 9.65 mm [.38 in]

Impedance: 50Ω

RF Connector Coupling Mechanism: Screw

Features

Product Type Features

RF Interface	OS 2.9
RF Connector Style	Jack
Connector System	Cable-to-Board
Connector & Contact Terminates To	Wire & Cable

Configuration Features

PCB Mount Orientation	Vertical
Number of Positions	1
Number of Coaxial Contacts	1

Electrical Characteristics

EMI & RFI Protection & Suppression Type	PCB Ground
Impedance	50 Ω

Body Features

Cable Connector Orientation	Straight
Body Material	Stainless Steel



Body Material Finish	Passivated
Contact Features	
RF Connector Center Contact Plating Material	Gold
RF Connector Center Contact Material	Beryllium Copper
Mechanical Attachment	
RF Connector Coupling Mechanism	Screw
RF Contact Captivation Method	Mechanical
Dimensions	
Profile Height from PCB	10.94 mm[.431 in]
RF Connector Mated Outer Diameter (Approximate)	9.65 mm[.38 in]
Usage Conditions	
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Operating Frequency	40 GHz
Circuit Application	Signal
Packaging Features	
Packaging Method	Bag
Other	
Dielectric Material	Polyetherimide (PEI)

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts









































Customers Also Bought















Documents

Product Drawings

2.92MM JACK 2 HOLE FLANGE RECEPTACLE

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2081570-1_A.2d_dxf.zip



English

Customer View Model

ENG_CVM_CVM_2081570-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2081570-1_A.3d_stp.zip

English

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Product Specifications

Product Specification

English

Product Environmental Compliance

Product Compliance Document

English

Product Compliance Document

English